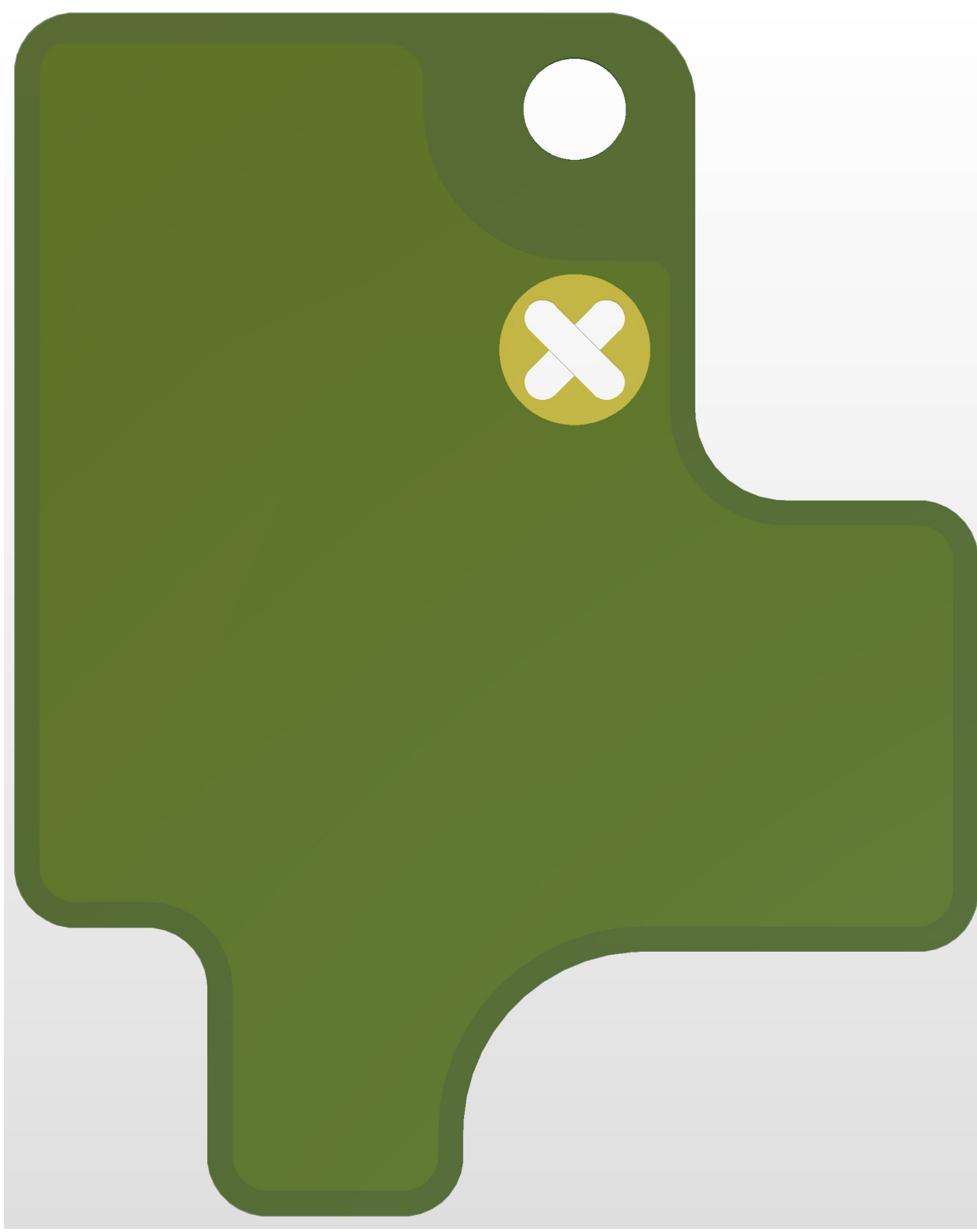


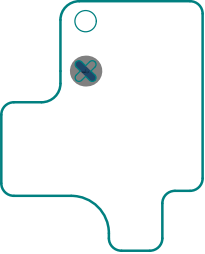


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Board Stack Report

Stack Up

Layer Stack

Layer	Flex	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	SM-001	0.025mm	4
4		Top Layer	Copper	0.035mm	
5		Dielectric 1	FlexCore	0.100mm	4.6
6		Bottom Layer	Copper		
7		Bottom Overlay			
	Height : 0.160mm				